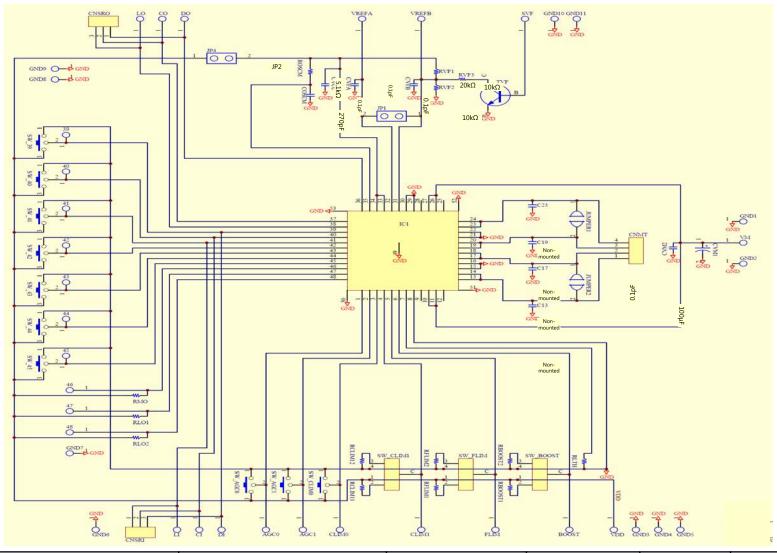
Circuit diagram - TB67S289FTG -



| Control Num. | TITLE | Function | Sheet Num. | Rev. | Date | 2018-09-21

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